

SMPS MOSFET

IRFBA90N20D

HEXFET® Power MOSFET

Applications

High frequency DC-DC converters

V _{DSS}	R _{DS(on)} max	I _D
200V	0.023 Ω	98A®

Benefits

- Low Gate-to-Drain Charge to Reduce Switching Losses
- Fully Characterized Capacitance Including Effective C_{OSS} to Simplify Design, (See App. Note AN1001)
- Fully Characterized Avalanche Voltage and Current



Absolute Maximum Ratings

	•		
	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V	986	
I _D @ T _C = 100°C	Continuous Drain Current, V _{GS} @ 10V	71⑥	Α
I _{DM}	Pulsed Drain Current ①	390	
P _D @T _C = 25°C	Power Dissipation	650	W
	Linear Derating Factor	4.3	W/°C
V_{GS}	Gate-to-Source Voltage	± 30	V
dv/dt	Peak Diode Recovery dv/dt 3	6.3	V/ns
TJ	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Recommended Clip Force	20	N

Thermal Resistance

	Parameter	Тур.	Max.	Units
R ₀ JC	Junction-to-Case		0.23	
R _{0CS}	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
$R_{\theta JA}$	Junction-to-Ambient		58	

Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	200			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.22		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.023	Ω	$V_{GS} = 10V, I_D = 59A$ ④
V _{GS(th)}	Gate Threshold Voltage	3.0		5.0	V	$V_{DS} = V_{GS}, I_D = 250\mu A$
I _{DSS}	Drain-to-Source Leakage Current			25	μA	$V_{DS} = 200V, V_{GS} = 0V$
יטאא	Biair to couldo Ecanago Carioni			250	μΛ	$V_{DS} = 160V, V_{GS} = 0V, T_{J} = 150$ °C
1	Gate-to-Source Forward Leakage			100	nA	$V_{GS} = 30V$
GSS	Gate-to-Source Reverse Leakage			-100	IIA I	$V_{GS} = -30V$

Dynamic @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions		
g _{fs}	Forward Transconductance	41			S	V _{DS} = 50V, I _D = 59A		
Qg	Total Gate Charge		160	240		I _D = 59A		
Q _{gs}	Gate-to-Source Charge		45	67	nC	$V_{DS} = 160V$		
Q _{gd}	Gate-to-Drain ("Miller") Charge		75	110	Ī	V _{GS} = 10V ④		
t _{d(on)}	Turn-On Delay Time		23			V _{DD} = 100V		
t _r	Rise Time		160		ns	I _D = 59A		
t _{d(off)}	Turn-Off Delay Time		39			$R_G = 1.2\Omega$		
t _f	Fall Time		77]	V _{GS} = 10V ④		
C _{iss}	Input Capacitance		6080			$V_{GS} = 0V$		
Coss	Output Capacitance		1040			$V_{DS} = 25V$		
C _{rss}	Reverse Transfer Capacitance		150		pF	f = 1.0MHz		
Coss	Output Capacitance		7500] [$V_{GS} = 0V$, $V_{DS} = 1.0V$, $f = 1.0MHz$		
Coss	Output Capacitance		410			$V_{GS} = 0V$, $V_{DS} = 160V$, $f = 1.0MHz$		
Coss eff.	Effective Output Capacitance		790			$V_{GS} = 0V$, $V_{DS} = 0V$ to 160V ③		

Avalanche Characteristics

	Parameter	Тур.	Max.	Units
E _{AS}	Single Pulse Avalanche Energy ^②		960	mJ
I _{AR}	Avalanche Current①		59	Α
E _{AR}	Repetitive Avalanche Energy①		65	mJ

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			_ 98		MOSFET symbol
	(Body Diode)			90	A	showing the
I _{SM}	Pulsed Source Current			390		integral reverse G
	(Body Diode) ①					p-n junction diode.
V _{SD}	Diode Forward Voltage			1.5	V	T _J = 25°C, I _S = 59A, V _{GS} = 0V ④
t _{rr}	Reverse Recovery Time		220	340	nS	T _J = 25°C, I _F = 59A
Q _{rr}	Reverse RecoveryCharge		1.9	2.8	μC	di/dt = 100A/μs ④
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S + L_D$)				

IRFBA90N20D

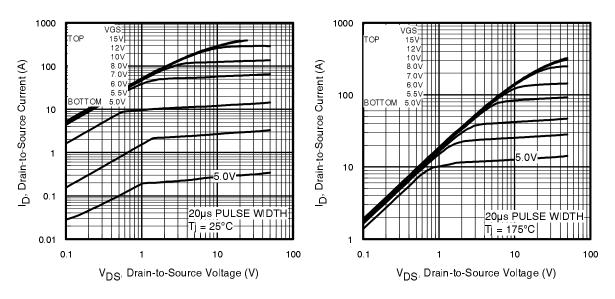


Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics

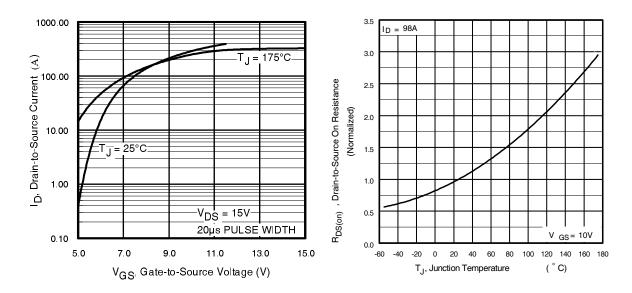


Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature

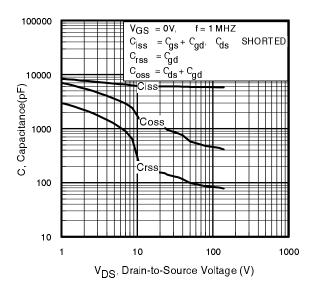


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

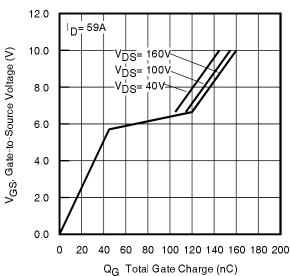


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

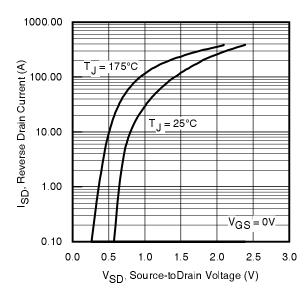


Fig 7. Typical Source-Drain Diode Forward Voltage

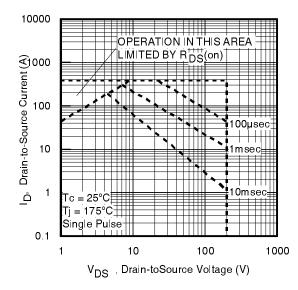


Fig 8. Maximum Safe Operating Area

International TOR Rectifier

IRFBA90N20D

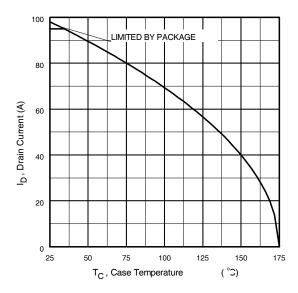


Fig 9. Maximum Drain Current Vs. Case Temperature

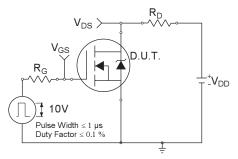


Fig 10a. Switching Time Test Circuit

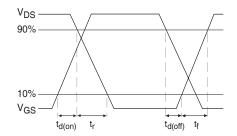


Fig 10b. Switching Time Waveforms

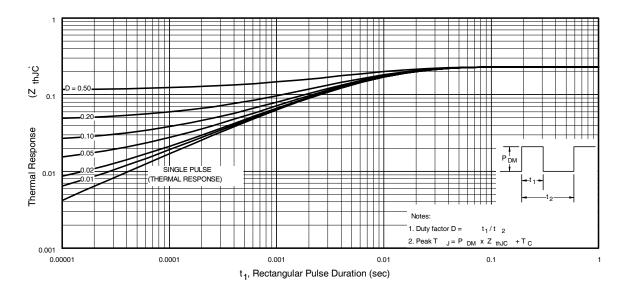


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

IRFBA90N20D

International TOR Rectifier

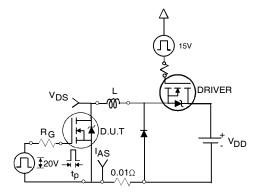


Fig 12a. Unclamped Inductive Test Circuit

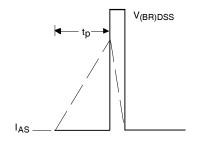


Fig 12b. Unclamped Inductive Waveforms

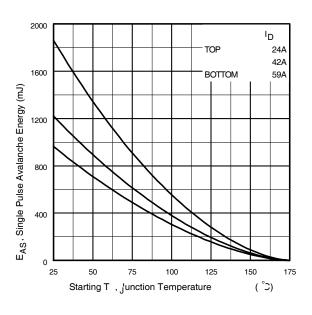


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

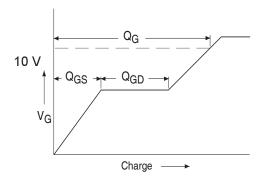


Fig 13a. Basic Gate Charge Waveform

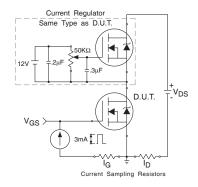
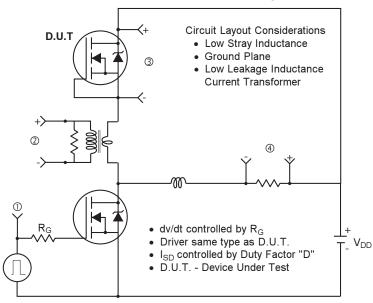
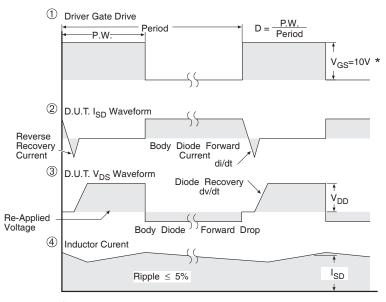


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit





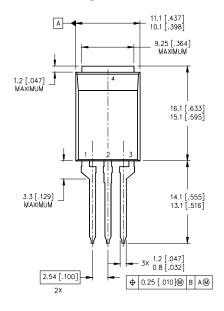
* V_{GS} = 5V for Logic Level Devices

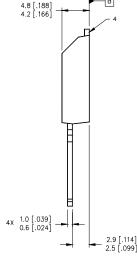
Fig 14. For N-Channel HEXFET® Power MOSFETs

IRFBA90N20D

International TOR Rectifier

Super-220™ Package Outline





NOTES:

- 1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: MILLIMETER.
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-273AA.

LEAD ASSIGNMENTS

MOSFET	IGBT
1 - GATE	1 - GATE
2 - DRAIN	2 - COLLECTOR
3 - SOURCE	3 - EMITTER
4 - DPAIN	4 - COLLECTOR

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Starting $T_J = 25$ °C, L = 0.55mH $R_G = 25\Omega$, $I_{AS} = 59$ A.
- ③ $I_{SD} \le 59A$, $di/dt \le 170A/\mu s$, $V_{DD} \le V_{(BR)DSS}$, $T_{.1} \le 175^{\circ}C$
- ④ Pulse width \leq 300 μ s; duty cycle \leq 2%.
- $\ ^{\circ}$ C $_{oss}$ eff. is a fixed capacitance that gives the same charging time as C $_{oss}$ while V $_{DS}$ is rising from 0 to 80% V $_{DSS}$
- © Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 95A.

Super-220™ not recommended for surface mount application.

Data and specifications subject to change without notice.

This product has been designed and qualified for the Industrial market.

Qualification Standards can be found on IR's Web site.



IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information.01/04